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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	372
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50se-7fn672c

Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
Packages and SERDES / I/O Combinations					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

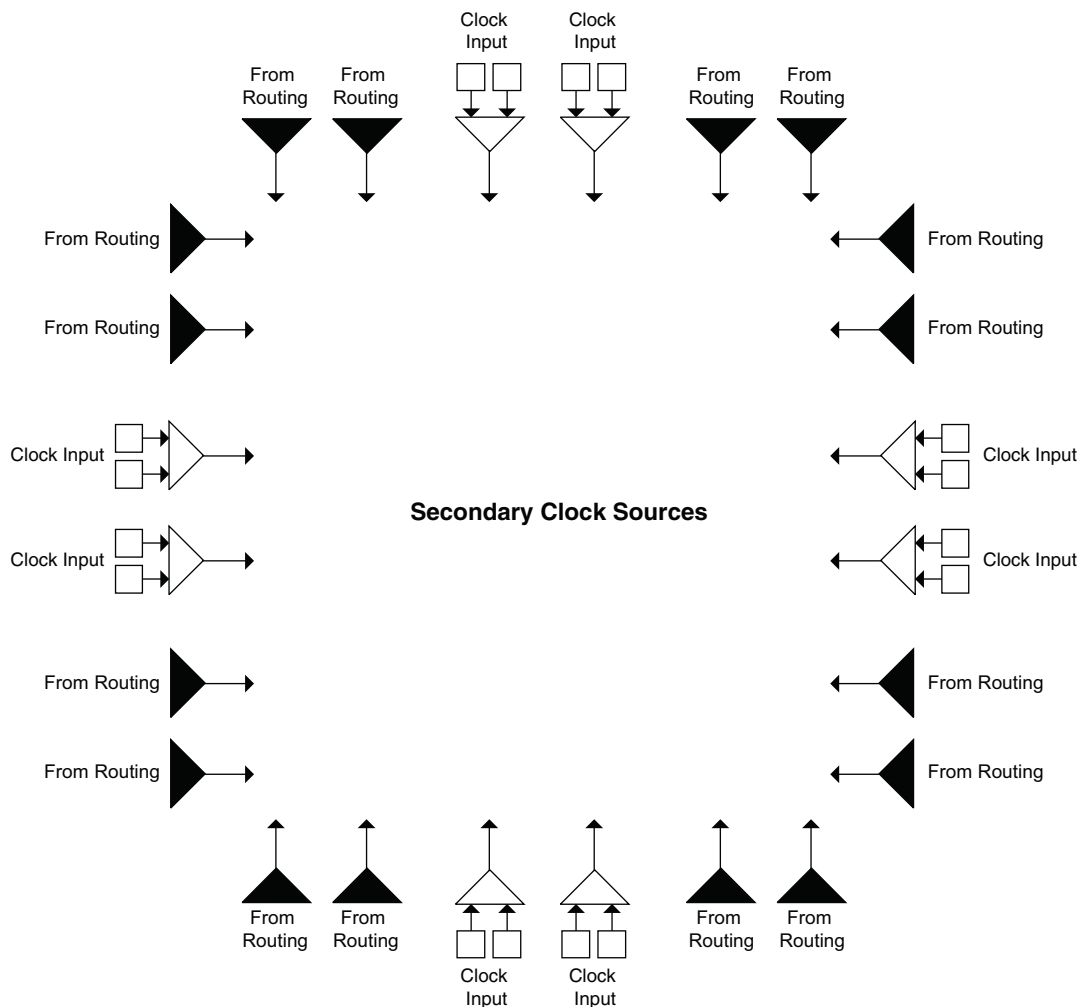
The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

Secondary Clock/Control Sources

LatticeECP2/M devices derive secondary clocks (SC0 through SC7) from eight dedicated clock input pads and the rest from routing. Figure 2-11 shows the secondary clock sources.

Figure 2-11. Secondary Clock Sources



DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$I_{IL}, I_{IH}^{1,2}$	Input or I/O Low Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) < V_{IN} \leq 3.6V$	—	—	150	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-210	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	210	μA
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7 V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \leq V_{IN} \leq V_{CCIO}$	—	—	210	μA
I_{BHHO}	Bus Hold High Overdrive Current	$0 \leq V_{IN} \leq V_{CCIO}$	—	—	-210	μA
V_{BHT}	Bus Hold Trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
$C1^4$	I/O Capacitance	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	5	8	pf
$C2^4$	Dedicated Input Capacitance	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	5	6	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. When used as V_{REF} maximum leakage = 25 μA
3. Applicable to general purpose I/Os in top and bottom banks.
4. T_A 25°C, $f = 1.0MHz$.

LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12

Pin Type		LFE2-6		LFE2-12			
		144 TQFP	256 fpBGA	144 TQFP	208 PQFP	256 fpBGA	484 fpBGA
Single Ended User I/O		90	190	93	131	193	297
Differential Pair User I/O		43	95	45	62	96	148
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	34	54	33	40	54	57
	Dedicated Pins	3	3	3	3	3	3
VCC		10	7	10	14	7	16
VCCAUX		4	4	4	8	4	16
VCCPLL		0	0	0	0	0	0
VCCIO	Bank0	1	2	1	2	2	4
	Bank1	1	2	1	2	2	4
	Bank2	1	2	1	2	2	4
	Bank3	1	2	1	2	2	4
	Bank4	1	2	1	2	2	4
	Bank5	1	2	1	2	2	4
	Bank6	1	2	1	2	2	4
	Bank7	1	2	1	2	2	4
	Bank8	1	1	1	2	1	2
GND, GND0 to GND7		12	20	12	22	20	60
NC		4	3	1	0	0	44
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	8/4	18/6	8/4	18/9	18/9	50/25
	Bank1	17/8	34/17	18/9	18/9	34/17	46/23
	Bank2	4/2	20/10	4/2	11/5	20/10	24/12
	Bank3	8/4	12/6	8/4	11/5	12/6	16/8
	Bank4	18/9	32/16	18/9	19/9	32/16	46/23
	Bank5	8/4	14/7	10/5	18/9	17/8	46/23
	Bank6	9/4	26/13	9/4	18/8	26/13	32/16
	Bank7	12/6	20/10	12/6	12/6	20/10	23/11
	Bank8	6/2	14/7	6/2	6/2	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	1	5	1	4	5	6
	Bank3 (Right Edge)	3	3	3	3	3	4
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	2	7	2	6	7	8
	Bank7 (Left Edge)	5	5	5	5	5	5
	Bank8 (Right Edge)	0	0	0	0	0	0

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 (Cont.)

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	2	2	2	4	4	4	4
	Bank3	2	1	1	3	4	3	5
	Bank4	3	1	3	3	3	3	3
	Bank5	2	3	3	2	3	2	3
	Bank6	1	2	2	3	4	3	5
	Bank7	3	3	3	4	4	4	5
	Bank8	0	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	0	0	0	0	72	0	80
	Bank3	0	0	0	0	64	0	80
	Bank4	50	24	48	48	40	48	44
	Bank5	60	60	50	40	40	40	46
	Bank6	52	54	60	62	66	62	82
	Bank7	60	60	68	70	74	70	90
	Bank8	0	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
W5	PL38B	6	LDQ42	C (LVDS)*	PL52B	6	LDQ56	C (LVDS)*	
AC1	PL39A	6	LDQ42	T	PL53A	6	LDQ56	T	
AD1	PL39B	6	LDQ42	C	PL53B	6	LDQ56	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y6	PL40A	6	LDQ42	T (LVDS)*	PL54A	6	LDQ56	T (LVDS)*	
Y5	PL40B	6	LDQ42	C (LVDS)*	PL54B	6	LDQ56	C (LVDS)*	
AE2	PL41A	6	LDQ42	T	PL55A	6	LDQ56	T	
AD2	PL41B	6	LDQ42	C	PL55B	6	LDQ56	C	
GND	GNDIO6	-			GNDIO6	-			
AB3	PL42A	6	LDQS42	T (LVDS)*	PL56A	6	LDQS56	T (LVDS)*	
AB2	PL42B	6	LDQ42	C (LVDS)*	PL56B	6	LDQ56	C (LVDS)*	
W7	PL43A	6	LDQ42	T	PL57A	6	LDQ56	T	
VCCIO	VCCIO6	6			VCCIO6	6			
W8	PL43B	6	LDQ42	C	PL57B	6	LDQ56	C	
Y7	PL44A	6	LDQ42	T (LVDS)*	PL58A	6	LDQ56	T (LVDS)*	
Y8	PL44B	6	LDQ42	C (LVDS)*	PL58B	6	LDQ56	C (LVDS)*	
AC2	PL45A	6	LDQ42	T	PL59A	6	LDQ56	T	
GND	GNDIO6	-			GNDIO6	-			
AD3	PL45B	6	LDQ42	C	PL59B	6	LDQ56	C	
AC3	TCK	-			TCK	-			
AA8	TDI	-			TDI	-			
AB4	TMS	-			TMS	-			
AA5	TDO	-			TDO	-			
AB5	VCCJ	-			VCCJ	-			
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
GND	GNDIO5	-			GNDIO5	-			
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G24	PR14B	2	RDQ16	C (LVDS)*	PR27B	2	RDQ29	C (LVDS)*	
G23	PR14A	2	RDQ16	T (LVDS)*	PR27A	2	RDQ29	T (LVDS)*	
VCCIO	VCCIO2	2			VCCIO2	2			
K19	PR13B	2	RDQ16	C	PR26B	2	RDQ29	C	
J19	PR13A	2	RDQ16	T	PR26A	2	RDQ29	T	
D26	PR12B	2	RDQ16	C (LVDS)*	PR25B	2	RDQ29	C (LVDS)*	
C26	PR12A	2	RDQ16	T (LVDS)*	PR25A	2	RDQ29	T (LVDS)*	
F22	PR11B	2	RDQ8	C	PR24B	2	RDQ21	C	
E24	PR11A	2	RDQ8	T	PR24A	2	RDQ21	T	
GND	GNDIO2	-			GNDIO2	-			
D25	PR10B	2	RDQ8	C (LVDS)*	PR23B	2	RDQ21	C (LVDS)*	
C25	PR10A	2	RDQ8	T (LVDS)*	PR23A	2	RDQ21	T (LVDS)*	
D24	PR9B	2	RDQ8	C	PR22B	2	RDQ21	C	
B25	PR9A	2	RDQ8	T	PR22A	2	RDQ21	T	
VCCIO	VCCIO2	2			VCCIO2	2			
H21	PR8B	2	RDQ8	C (LVDS)*	PR21B	2	RDQ21	C (LVDS)*	
G22	PR8A	2	RDQS8	T (LVDS)*	PR21A	2	RDQS21	T (LVDS)*	
B24	PR7B	2	RDQ8	C	PR20B	2	RDQ21	C	
GND	GNDIO2	-			GNDIO2	-			
C24	PR7A	2	RDQ8	T	PR20A	2	RDQ21	T	
D23	PR6B	2	RDQ8	C (LVDS)*	PR19B	2	RDQ21	C (LVDS)*	
C23	PR6A	2	RDQ8	T (LVDS)*	PR19A	2	RDQ21	T (LVDS)*	
G21	PR5B	2	RDQ8	C	PR18B	2	RDQ21	C	
VCCIO	VCCIO2	2			VCCIO2	2			
H20	PR5A	2	RDQ8	T	PR18A	2	RDQ21	T	
GND	GNDIO2	-			GNDIO2	-			
E22	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
F21	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
E23	PT82B	1	VREF2_1	C	PT100B	1	VREF2_1	C	
GND	GNDIO1	-			GNDIO1	-			
D22	PT82A	1	VREF1_1	T	PT100A	1	VREF1_1	T	
G20	PT81B	1		C	PT99B	1		C	
J18	PT81A	1		T	PT99A	1		T	
F20	PT80B	1		C	PT98B	1		C	
VCCIO	VCCIO1	1			VCCIO1	1			
H19	PT80A	1		T	PT98A	1		T	
A24	PT79B	1		C	PT97B	1		C	
A23	PT79A	1		T	PT97A	1		T	
E21	PT78B	1		C	PT96B	1		C	
F19	PT78A	1		T	PT96A	1		T	
C22	PT77B	1		C	PT95B	1		C	
GND	GNDIO1	-			GNDIO1	-			
E20	PT77A	1		T	PT95A	1		T	
B22	PT76B	1		C	PT94B	1		C	
VCCIO	VCCIO1	1			VCCIO1	1			
B23	PT76A	1		T	PT94A	1		T	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
W7	PL72B	6	LDQ71	C
W4	PL73A	6	LLM0_GDLLT_IN_A**/LDQ71	T (LVDS)*
W3	PL73B	6	LLM0_GDLLC_IN_A**/LDQ71	C (LVDS)*
W6	PL74A	6	LLM0_GDLLT_FB_A/LDQ71	T
GND	GNDIO6	-		
W8	PL74B	6	LLM0_GDLLC_FB_D/LDQ71	C
Y8	LLM0_PLLCAP	6		
Y1	PL76A	6	LLM0_GPLLT_IN_A**/LDQ80	T (LVDS)*
Y2	PL76B	6	LLM0_GPLLC_IN_A**/LDQ80	C (LVDS)*
Y5	PL77A	6	LLM0_GPLLT_FB_A/LDQ80	T
Y6	PL77B	6	LLM0_GPLLC_FB_A/LDQ80	C
Y4	PL78A	6	LDQ80	T (LVDS)*
VCCIO	VCCIO6	6		
Y3	PL78B	6	LDQ80	C (LVDS)*
AA6	PL79A	6	LDQ80	T
AA8	PL79B	6	LDQ80	C
AA2	PL80A	6	LDQS80	T (LVDS)*
GND	GNDIO6	-		
AA1	PL80B	6	LDQ80	C (LVDS)*
AA7	PL81A	6	LDQ80	T
AA5	PL81B	6	LDQ80	C
VCCIO	VCCIO6	6		
AA4	PL82A	6	LDQ80	T (LVDS)*
AA3	PL82B	6	LDQ80	C (LVDS)*
AB7	PL83A	6	LDQ80	T
AB5	PL83B	6	LDQ80	C
GND	GNDIO6	-		
AB2	PL84A	6	LDQ88	T (LVDS)*
AB1	PL84B	6	LDQ88	C (LVDS)*
AB8	PL85A	6	LDQ88	T
AB6	PL85B	6	LDQ88	C
VCCIO	VCCIO6	6		
AB4	PL86A	6	LDQ88	T (LVDS)*
AB3	PL86B	6	LDQ88	C (LVDS)*
AC7	PL87A	6	LDQ88	T
AC5	PL87B	6	LDQ88	C
GND	GNDIO6	-		
AC2	PL88A	6	LDQS88	T (LVDS)*
AC1	PL88B	6	LDQ88	C (LVDS)*
AC6	PL89A	6	LDQ88	T
VCCIO	VCCIO6	6		
AD6	PL89B	6	LDQ88	C
AD1	PL90A	6	LDQ88	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R19	GND	-		
R20	GND	-		
T11	GND	-		
T12	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T19	GND	-		
T20	GND	-		
U11	GND	-		
U12	GND	-		
U13	GND	-		
U14	GND	-		
U15	GND	-		
U16	GND	-		
U17	GND	-		
U18	GND	-		
U19	GND	-		
U20	GND	-		
V12	GND	-		
V13	GND	-		
V14	GND	-		
V15	GND	-		
V16	GND	-		
V17	GND	-		
V18	GND	-		
V19	GND	-		
V28	GND	-		
V3	GND	-		
W12	GND	-		
W13	GND	-		
W14	GND	-		
W15	GND	-		
W16	GND	-		
W17	GND	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E27	NC	-		
E28	NC	-		
E29	NC	-		
E3	NC	-		
E30	NC	-		
E4	NC	-		
E5	NC	-		
E6	NC	-		
F25	NC	-		
F5	NC	-		
F6	NC	-		
G6	NC	-		
G7	NC	-		
K10	NC	-		
K9	NC	-		
N27	NC	-		
N4	NC	-		
R1	NC	-		
R2	NC	-		
V27	NC	-		
V4	NC	-		
P22	VCCPLL	-		
P8	VCCPLL	-		
T22	VCCPLL	-		
Y7	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N11	CCLK	8			CCLK	8		
M11	INITN	8			INITN	8		
N13	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
M12	PR53B	8	WRITEN	C	PR68B	8	WRITEN	C
M13	PR53A	8	CS1N	T	PR68A	8	CS1N	T
N14	PR52B	8	CSN	C	PR67B	8	CSN	C
N15	PR52A	8	D0/SPIFASTN	T	PR67A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8			VCCIO8	8		
N16	PR51B	8	D1	C	PR66B	8	D1	C
M16	PR51A	8	D2	T	PR66A	8	D2	T
L12	PR50B	8	D3	C	PR65B	8	D3	C
GNDIO	GNDIO8	-			GNDIO8	-		
L13	PR50A	8	D4	T	PR65A	8	D4	T
L16	PR49B	8	D5	C	PR64B	8	D5	C
K16	PR49A	8	D6	T	PR64A	8	D6	T
L14	PR48B	8	D7/SPID0***	C	PR63B	8	D7/SPID0***	C
VCCIO	VCCIO8	8			VCCIO8	8		
L15	PR48A	8	DI/CSSPI0N	T	PR63A	8	DI/CSSPI0N	T
K13	PR47B	8	DOUT/CSON/CSSPI1N	C	PR62B	8	DOUT/CSON/CSSPI1N	C
K14	PR47A	8	BUSY/SISPI	T	PR62A	8	BUSY/SISPI	T
K11	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
K15	PR45B	3	RLM0_GDLLC_FB_A	C	PR60B	3	RLM0_GDLLC_FB_A/RDQ57	C
GNDIO	GNDIO3	-			GNDIO3	-		
J16	PR45A	3	RLM0_GDLLT_FB_A	T	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T
H16	PR44B	3	RLM0_GDLLC_IN_A	C (LVDS)*	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C (LVDS)*
J15	PR44A	3	RLM0_GDLLT_IN_A	T (LVDS)*	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*
J14	PR43B	3	RLM0_GPLLC_IN_A	C	PR58B	3	RLM0_GPLLC_IN_A**/RDQ57	C
VCCIO	VCCIO3	3			VCCIO3	3		
J13	PR43A	3	RLM0_GPLLT_IN_A	T	PR58A	3	RLM0_GPLLT_IN_A**/RDQ57	T
H13	PR42B	3	RLM0_GPLLC_FB_A	C (LVDS)*	PR57B	3	RLM0_GPLLC_FB_A/RDQ57	C (LVDS)*
H12	PR42A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR57A	3	RLM0_GPLLT_FB_A/RDQS57***	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
VCCIO	VCCIO3	3			VCCIO3	3		
G16	PR32B	3	RLM1_SPLLC_FB_A	C	PR42B	3	RLM2_SPLLC_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
H15	PR32A	3	RLM1_SPLLT_FB_A	T	PR42A	3	RLM2_SPLLT_FB_A	T
E16	PR31B	3	RLM1_SPLLC_IN_A	C (LVDS)*	PR41B	3	RLM2_SPLLC_IN_A	C (LVDS)*
F15	PR31A	3	RLM1_SPLLT_IN_A	T (LVDS)*	PR41A	3	RLM2_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
VCCIO	VCCIO3	3			VCCIO3	3		
F16	PR28B	3	VREF2_3	C	PR38B	3	VREF2_3	C
G15	PR28A	3	VREF1_3	T	PR38A	3	VREF1_3	T
J11	PR27B	3	PCLKC3_0	C (LVDS)*	PR37B	3	PCLKC3_0	C (LVDS)*
J12	PR27A	3	PCLKT3_0	T (LVDS)*	PR37A	3	PCLKT3_0	T (LVDS)*
G14	PR25B	2	PCLKC2_0/RDQ22	C	PR35B	2	PCLKC2_0/RDQ32	C
G13	PR25A	2	PCLKT2_0/RDQ22	T	PR35A	2	PCLKT2_0/RDQ32	T
GNDIO	GNDIO2	-			GNDIO2	-		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M19	PR50A	3	RDQ52	T (LVDS)*
M18	PR49B	3	RDQ52	C
VCCIO	VCCIO3	3		
L16	PR49A	3	RDQ52	T
L22	PR48B	3	RDQ52	C (LVDS)*
L21	PR48A	3	RDQ52	T (LVDS)*
GNDIO	GNDIO3	-		
K22	PR46B	3	RLM3_SPLLC_FB_A	C
VCCIO	VCCIO3	3		
K21	PR46A	3	RLM3_SPLLT_FB_A	T
L17	PR45B	3	RLM3_SPLLC_IN_A	C (LVDS)*
L18	PR45A	3	RLM3_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO3	-		
L20	PR44B	3		C
L19	PR44A	3		T
K16	PR43B	3		C (LVDS)*
K17	PR43A	3		T (LVDS)*
VCCIO	VCCIO3	3		
J16	PR42B	3	VREF2_3	C
K18	PR42A	3	VREF1_3	T
J22	PR41B	3	PCLKC3_0	C (LVDS)*
J21	PR41A	3	PCLKT3_0	T (LVDS)*
H22	PR39B	2	PCLKC2_0/RDQ36	C
H21	PR39A	2	PCLKT2_0/RDQ36	T
GNDIO	GNDIO2	-		
J17	PR38B	2	RDQ36	C (LVDS)*
J18	PR38A	2	RDQ36	T (LVDS)*
J20	PR37B	2	RDQ36	C
J19	PR37A	2	RDQ36	T
VCCIO	VCCIO2	2		
H16	PR36B	2	RDQ36	C (LVDS)*
H17	PR36A	2	RDQS36	T (LVDS)*
G22	PR35B	2	RDQ36	C
GNDIO	GNDIO2	-		
G21	PR35A	2	RDQ36	T
H20	PR34B	2	RDQ36	C (LVDS)*
H19	PR34A	2	RDQ36	T (LVDS)*
G16	PR33B	2	RUM3_SPLLC_FB_A/RDQ36	C
VCCIO	VCCIO2	2		
H18	PR33A	2	RUM3_SPLLT_FB_A/RDQ36	T
F22	PR32B	2	RUM3_SPLLC_IN_A/RDQ36	C (LVDS)*
F21	PR32A	2	RUM3_SPLLT_IN_A/RDQ36	T (LVDS)*
G20	PR30B	2	RDQ27	C

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P8	PL45A	6	LDQ48	T	PL49A	6	LDQ52	T	
R6	PL45B	6	LDQ48	C	PL49B	6	LDQ52	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T1	PL46A	6	LDQ48	T (LVDS)*	PL50A	6	LDQ52	T*	
U1	PL46B	6	LDQ48	C (LVDS)*	PL50B	6	LDQ52	C*	
R7	PL47A	6	LDQ48	T	PL51A	6	LDQ52	T	
T5	PL47B	6	LDQ48	C	PL51B	6	LDQ52	C	
GNDIO	GNDIO6	-			GNDIO6	-			
U3	PL48A	6	LDQS48	T (LVDS)*	PL52A	6	LDQS52	T*	
U4	PL48B	6	LDQ48	C (LVDS)*	PL52B	6	LDQ52	C*	
U5	PL49A	6	LDQ48	T	PL53A	6	LDQ52	T	
VCCIO	VCCIO6	6			VCCIO6	6			
U6	PL49B	6	LDQ48	C	PL53B	6	LDQ52	C	
U2	PL50A	6	LDQ48	T (LVDS)*	PL54A	6	LDQ52	T*	
V1	PL50B	6	LDQ48	C (LVDS)*	PL54B	6	LDQ52	C*	
W2	PL51A	6	LDQ48	T	PL55A	6	LDQ52	T	
GNDIO	GNDIO6	-			GNDIO6	-			
V2	PL51B	6	LDQ48	C	PL55B	6	LDQ52	C	
V4	PL55A	6	LDQ57	T (LVDS)*	PL59A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
V3	PL55B	6	LDQ57	C (LVDS)*	PL59B	6		C*	
-	-	-			GNDIO6	-			
W4	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57****	T (LVDS)*	PL62A	6	LLM0_GPLLT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
W3	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*	PL62B	6	LLM0_GPLLC_IN_A	C*	
W1	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T	PL63A	6	LLM0_GPLLT_FB_A	T	
Y1	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C	PL63B	6	LLM0_GPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
AA1	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*	PL64A	6	LLM0_GDLLT_IN_A	T*	
AB1	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	PL64B	6	LLM0_GDLLC_IN_A	C*	
U7	PL60A	6	LLM0_GDLLT_FB_A/LDQ57	T	PL65A	6	LLM0_GDLLT_FB_A	T	
V6	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C	PL65B	6	LLM0_GDLLC_FB_A	C	
GNDIO	GNDIO6	-			GNDIO6	-			
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
W5	PL62A	6	LDQ66	T (LVDS)*	PL67A	6	LDQ71	T*	
Y4	PL62B	6	LDQ66	C (LVDS)*	PL67B	6	LDQ71	C*	
U8	PL63A	6	LDQ66	T	PL68A	6	LDQ71	T	
W6	PL63B	6	LDQ66	C	PL68B	6	LDQ71	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y3	PL64A	6	LDQ66	T (LVDS)*	PL69A	6	LDQ71	T*	
AA3	PL64B	6	LDQ66	C (LVDS)*	PL69B	6	LDQ71	C*	
V7	NC	-			PL70A	6	LDQ71	T	
Y5	PL65B	6	LDQ66	C	PL70B	6	LDQ71	C	
GNDIO	GNDIO6	-			GNDIO6	-			
AB2	PL66A	6	LDQS66	T (LVDS)*	PL71A	6	LDQS71	T*	
AA4	PL66B	6	LDQ66	C (LVDS)*	PL71B	6	LDQ71	C*	
Y6	PL67A	6	LDQ66	T	PL72A	6	LDQ71	T	
VCCIO	VCCIO6	6			VCCIO6	6			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
W17	PB65A	4	BDQ69	T	PB56A	4	BDQ60	T	
AA19	PB65B	4	BDQ69	C	PB56B	4	BDQ60	C	
AC15	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T	
Y18	PB68B	4	BDQ69	C	PB57B	4	BDQ60	C	
AB15	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T	
AC16	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AA17	PB60A	4	BDQS60****	T	PB59A	4	BDQ60	T	
AB16	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AA15	PB51A	4	BDQS51****	T	PB60A	4	BDQS60	T	
W16	PB59B	4	BDQ60	C	PB60B	4	BDQ60	C	
Y15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AC17	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AA18	PB61A	4	BDQ60	T	PB62A	4	BDQ60	T	
Y17	PB61B	4	BDQ60	C	PB62B	4	BDQ60	C	
-	-	-			VCCIO4	4			
GNDIO	GNDIO4	-			-	-			
W15	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
AB17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
VCCIO	VCCIO4	4			VCCIO4	4			
V17	PB73A	4	BDQ69	T	PB72A	4	BDQ69	T	
AA20	PB73B	4	BDQ69	C	PB72B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD13	VCC	-			LRC_SQ_VCCRX3	13			
AF14	PB47A	4	BDQ51	T	LRC_SQ_HDINP3	13		T	
AE13	NC	-			LRC_SQ_VCCIB3	13			
AE14	PB41A	4	VREF2_4/BDQ42	T	LRC_SQ_HDINN3	13		C	
AD16	VCC	-			LRC_SQ_VCCTX3	13			
AF17	PB51B	4	BDQ51	C	LRC_SQ_HDOUTP3	13		T	
AF16	NC	-			LRC_SQ_VCCOB3	13			
AE17	PB50A	4	BDQ51	T	LRC_SQ_HDOUTN3	13		C	
AD17	VCC	-			LRC_SQ_VCCTX2	13			
AE18	PB53B	4	BDQ51	C	LRC_SQ_HDOUTN2	13		C	
AD18	NC	-			LRC_SQ_VCCOB2	13			
AF18	PB53A	4	BDQ51	T	LRC_SQ_HDOUTP2	13		T	
AD14	VCC	-			LRC_SQ_VCCRX2	13			
AE15	PB48B	4	BDQ51	C	LRC_SQ_HDINN2	13		C	
AD15	NC	-			LRC_SQ_VCCIB2	13			
AF15	PB47B	4	BDQ51	C	LRC_SQ_HDINP2	13		T	
AD19	VCC	-			LRC_SQ_VCCP	13			
AC19	PB57B	4	BDQ60	C	LRC_SQ_REFCLKP	13		T	
AB19	PB59A	4	BDQ60	T	LRC_SQ_REFCLKN	13		C	
AE19	VCCAUX	-			LRC_SQ_VCCAUX33	13			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D23	NC	-			NC	-			
D24	NC	-			NC	-			
D25	NC	-			NC	-			
D26	NC	-			NC	-			
E20	NC	-			NC	-			
E21	NC	-			NC	-			
E25	NC	-			NC	-			
E26	NC	-			NC	-			
F20	NC	-			NC	-			
G20	NC	-			NC	-			
K10	NC	-			NC	-			
K17	NC	-			NC	-			
R4	NC	-			NC	-			
U10	NC	-			NC	-			
U23	NC	-			NC	-			
V10	NC	-			NC	-			
W7	NC	-			NC	-			
AB21	PB69B	4	BDQ69	C	NC	-			
AC20	PB58A	4	BDQ60	T	NC	-			
AC21	PB63A	4	BDQ60	T	NC	-			
AC22	PB69A	4	BDQS69****	T	NC	-			
AC23	PB71A	4	BDQ69	T	NC	-			
AC25	PB71B	4	BDQ69	C	NC	-			
AD26	PB70B	4	BDQ69	C	NC	-			
W20	PB72B	4	BDQ69	C	NC	-			
H7	L_VCCPLL	-			L_VCCPLL	-			
K6	L_VCCPLL	-			L_VCCPLL	-			
P7	L_VCCPLL	-			L_VCCPLL	-			
R8	L_VCCPLL	-			L_VCCPLL	-			
V18	R_VCCPLL	-			R_VCCPLL	-			
P20	R_VCCPLL	-			R_VCCPLL	-			
J17	R_VCCPLL	-			R_VCCPLL	-			
G19	R_VCCPLL	-			R_VCCPLL	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K3	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M7	VCCIO7	7			VCCIO7	7			
N10	VCCIO7	7			VCCIO7	7			
N3	VCCIO7	7			VCCIO7	7			
P10	VCCIO7	7			VCCIO7	7			
R6	VCCIO7	7			VCCIO7	7			
AA25	VCCIO8	8			VCCIO8	8			
AD28	VCCIO8	8			VCCIO8	8			
AA10	VCCAUX	-			VCCAUX	-			
AA11	VCCAUX	-			VCCAUX	-			
AA20	VCCAUX	-			VCCAUX	-			
AA21	VCCAUX	-			VCCAUX	-			
K10	VCCAUX	-			VCCAUX	-			
K11	VCCAUX	-			VCCAUX	-			
K20	VCCAUX	-			VCCAUX	-			
K21	VCCAUX	-			VCCAUX	-			
L10	VCCAUX	-			VCCAUX	-			
L11	VCCAUX	-			VCCAUX	-			
L20	VCCAUX	-			VCCAUX	-			
L21	VCCAUX	-			VCCAUX	-			
Y10	VCCAUX	-			VCCAUX	-			
Y11	VCCAUX	-			VCCAUX	-			
Y20	VCCAUX	-			VCCAUX	-			
Y21	VCCAUX	-			VCCAUX	-			
A1	GND	-			GND	-			
A13	GND	-			GND	-			
A18	GND	-			GND	-			
A24	GND	-			GND	-			
A30	GND	-			GND	-			
A7	GND	-			GND	-			
AA14	GND	-			GND	-			
AA15	GND	-			GND	-			
AA16	GND	-			GND	-			
AA17	GND	-			GND	-			
AA24	GND	-			GND	-			
AA27	GND	-			GND	-			
AA4	GND	-			GND	-			
AB24	GND	-			GND	-			
AB7	GND	-			GND	-			
AD12	GND	-			GND	-			
AD19	GND	-			GND	-			
AD27	GND	-			GND	-			
AE22	GND	-			GND	-			
AE27	GND	-			GND	-			
AE4	GND	-			GND	-			
AE9	GND	-			GND	-			
AF14	GND	-			GND	-			

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M2	PL26A	7	LDQ28	T (LVDS)*	PL30A	7	LDQ32	T (LVDS)*
M1	PL26B	7	LDQ28	C (LVDS)*	PL30B	7	LDQ32	C (LVDS)*
L6	PL27A	7	LDQ28	T	PL31A	7	LDQ32	T
L5	PL27B	7	LDQ28	C	PL31B	7	LDQ32	C
GNDIO	GNDIO7	-			GNDIO7	-		
L3	PL28A	7	LDQS28	T (LVDS)*	PL32A	7	LDQS32	T (LVDS)*
L4	PL28B	7	LDQ28	C (LVDS)*	PL32B	7	LDQ32	C (LVDS)*
M3	PL29A	7	LDQ28	T	PL33A	7	LDQ32	T
VCCIO	VCCIO7	7			VCCIO7	7		
M4	PL29B	7	LDQ28	C	PL33B	7	LDQ32	C
N1	PL30A	7	LDQ28	T (LVDS)*	PL34A	7	LDQ32	T (LVDS)*
N2	PL30B	7	LDQ28	C (LVDS)*	PL34B	7	LDQ32	C (LVDS)*
M5	PL31A	7	LDQ28	T	PL35A	7	LDQ32	T
GNDIO	GNDIO7	-			GNDIO7	-		
N6	PL31B	7	LDQ28	C	PL35B	7	LDQ32	C
P3	NC	-			PL37A	7		T (LVDS)*
-	-	-			GNDIO7	-		
P4	NC	-			PL37B	7		C (LVDS)*
P9	NC	-			PL38A	7		T
M7	NC	-			PL38B	7		C
-	-	-			VCCIO7	7		
P1	NC	-			PL39A	7		T (LVDS)*
P2	NC	-			PL39B	7		C (LVDS)*
N7	NC	-			PL40A	7		T
P7	NC	-			PL40B	7		C
-	-	-			GNDIO7	-		
P5	PL33A	7	LDQ37	T (LVDS)*	PL41A	7	LDQ45	T (LVDS)*
N5	PL33B	7	LDQ37	C (LVDS)*	PL41B	7	LDQ45	C (LVDS)*
P8	PL34A	7	LDQ37	T	PL42A	7	LDQ45	T
P6	PL34B	7	LDQ37	C	PL42B	7	LDQ45	C
VCCIO	VCCIO7	7			VCCIO7	7		
R3	PL35A	7	LDQ37	T (LVDS)*	PL43A	7	LDQ45	T (LVDS)*
R4	PL35B	7	LDQ37	C (LVDS)*	PL43B	7	LDQ45	C (LVDS)*
R10	PL36A	7	LDQ37	T	PL44A	7	LDQ45	T
P11	PL36B	7	LDQ37	C	PL44B	7	LDQ45	C
GNDIO	GNDIO7	-			GNDIO7	-		
R7	PL37A	7	LDQS37	T (LVDS)*	PL45A	7	LDQS45	T (LVDS)*
R8	PL37B	7	LDQ37	C (LVDS)*	PL45B	7	LDQ45	C (LVDS)*
R5	PL38A	7	LDQ37	T	PL46A	7	LDQ45	T
VCCIO	VCCIO7	7			VCCIO7	7		
T5	PL38B	7	LDQ37	C	PL46B	7	LDQ45	C
R1	PL39A	7	LDQ37	T (LVDS)*	PL47A	7	LDQ45	T (LVDS)*
R2	PL39B	7	LDQ37	C (LVDS)*	PL47B	7	LDQ45	C (LVDS)*
R11	PL40A	7	LDQ37	T	PL48A	7	LDQ45	T
GNDIO	GNDIO7	-			GNDIO7	-		
T10	PL40B	7	LDQ37	C	PL48B	7	LDQ45	C
T1	PL42A	7	LUM3_SPLLT_IN_A/LDQ46	T (LVDS)*	PL50A	7	LUM3_SPLLT_IN_A/LDQ54	T (LVDS)*
T2	PL42B	7	LUM3_SPLLC_IN_A/LDQ46	C (LVDS)*	PL50B	7	LUM3_SPLLC_IN_A/LDQ54	C (LVDS)*
U10	PL43A	7	LUM3_SPLLT_FB_A/LDQ46	T	PL51A	7	LUM3_SPLLT_FB_A/LDQ54	T

LatticeECP2 Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20